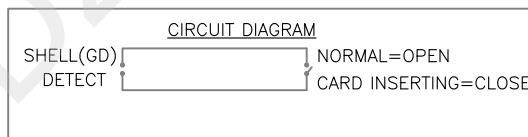
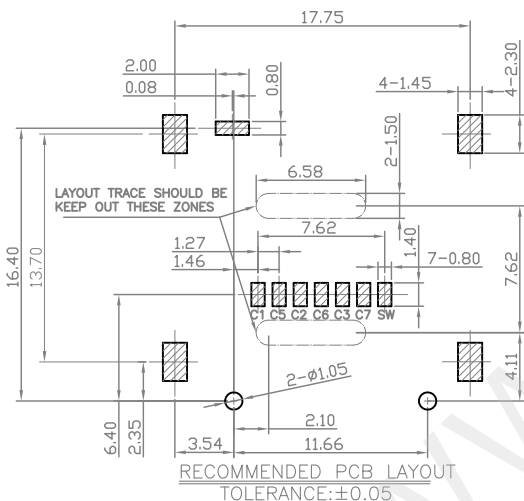


MICRO SIM CARD



NOTES:

1.MATERIAL:

- 1.1 Housing: High Temperature Thermoplastic UL94V-0, Color:Black
- 1.2 Terminal:Copper Alloy
- 1.3 Shell:Stainless Steel
- 1.4 Lever:Stainless Steel
- 1.5 Cam:Stainless Steel

2.FINISH:

- 2.1 Terminal:Gold flash plating on contact area, Gold flash plating on the solder tails.
- 2.2 Shell:Gold flash plating on the solder tails.

3.SPECIALITY:

- 3.1 Rated Current:0.5A
- 3.2 Rated Voltage:30V
- 3.3 Contact Resistance:50mΩ Max
- 3.4 Insulation Resistance:1000MΩ Min 100V DC
- 3.5 Dielectric Withstanding Voltage:500V AC
- 3.6 Solder Ability:245±5°C;5±0.5s
- 3.7 Durability:5000 cycles
- 3.8 Operating Condition:Temperature:-40°C~+85°C; Humidity:80%R.H Max

PIN No	DESCRIPTION
C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED
SW	SWITCH



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: MICRO SIM 1.5H
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC48-SIM06-150
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	DRAW NO: HVC-SIM13041021
			SHEET NO. 1 OF 1